

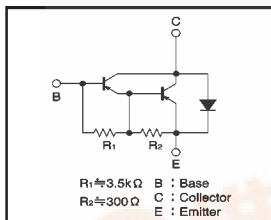
Power Transistor (-100V, -2A)

2SB1580 / 2SB1316 / 2SB1567 / 2SB1287

● Features

- 1) Darlington connection for high DC current gain.
- 2) Built-in resistor between base and emitter.
- 3) Built-in damper diode.
- 4) Complements the 2SD2195 / 2SD1980 / 2SD2398 / 2SD1765.

● Circuit diagram



● Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BVC _{BO}	-100	—	—	V	I _c =-50 μA
Collector-emitter breakdown voltage	BVC _{EO}	-100	—	—	V	I _c =-5mA
Collector cutoff current	I _{CBO}	—	—	-10	μA	V _{CB} =-100V
Emitter cutoff current	I _{EBO}	—	—	-3	mA	V _{EB} =-7V
Collector-emitter saturation voltage	V _{CE(sat)}	—	—	-1.5	V	I _c /I _e =-1A/-1mA
DC current transfer ratio	h _{FE}	1000	—	10000	—	V _{CE} =-2V, I _c =-1A
Output capacitance	C _{OB}	—	35	—	pF	V _{CB} =-10V, I _e =0A, f=1MHz

* Measured using pulse current.

(96-139-B85)

● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CBO}	-100	V
Collector-emitter voltage	V _{C EO}	-100	V
Emitter-base voltage	V _{EBO}	-8	V
Collector current	I _c	-2	A (DC)
		-3	A (Pulse) *1
Collector power dissipation	P _c	2 10 2 20	W (T _c =25°C) W (T _c =25°C)
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55~+150	°C

*1 Single pulse P_w=100ms *2 When mounted on a 40 x 40 x 0.7 mm ceramic board.

● Packaging specifications and h_{FE}

Type	2SB1580	2SB1316	2SB1567	2SB1287
Package	MPT3	CPT3	TO-220FN	TO-220FP
h _{FE}	1k~10k	1k~10k	1k~10k	1k~10k
Marking	BN*	—	—	—
Code	T100	TL	—	—
Basic ordering unit (pieces)	1000	2500	500	500

* Denotes h_{FE}

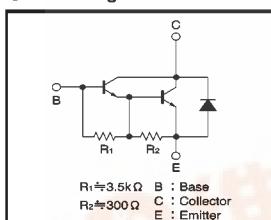
Power Transistor (100V, 2A)

2SD2195 / 2SD1980 / 2SD1867 / 2SD2398 / 2SD1765

● Features

- 1) Darlington connection for high DC current gain.
- 2) Built-in resistor between base and emitter.
- 3) Built-in damper diode.
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● Circuit diagram



● Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BVC _{BO}	100	—	—	V	I _c =50 μA
Collector-emitter breakdown voltage	BVC _{EO}	100	—	—	V	I _c =5mA
Collector cutoff current	I _{CBO}	—	—	10	μA	V _{CB} =100V
Emitter cutoff current	I _{EBO}	—	—	3	mA	V _{EB} =5V
Collector-emitter saturation voltage	V _{CE(sat)}	—	—	1.5	V	I _c =1A, I _e =1mA
DC current transfer ratio	h _{FE}	1000	—	10000	—	V _{CE} =2V, I _c =1A
Output capacitance	C _{OB}	—	25	—	pF	V _{CB} =10V, I _e =0A, f=1MHz

* Measured using pulse current.

● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CBO}	100	V
Collector-emitter voltage	V _{C EO}	100	V
Emitter-base voltage	V _{EBO}	6	V
Collector current	I _c	2	A (DC)
		3	A (Pulse) *1
Collector power dissipation	P _c	2 10 1 2 20	W (T _c =25°C) W (T _c =25°C) W (T _c =25°C)
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55~+150	°C

*1 Single pulse P_w=100ms *2 When mounted on a 40 x 40 x 0.7 mm ceramic board.

*3 Printed circuit board, 1.7mm thick, collector plating 100mm² or larger.

● Packaging specifications and h_{FE}

Type	2SD2195	2SD1980	2SD1867	2SD2398	2SD1765
Package	MPT3	CPT3	ATV	TO-220FN	TO-220FP
h _{FE}	1k~10k	1k~10k	1k~10k	1k~10k	1k~10k
Marking	DP*	—	—	—	—
Code	T100	TL	TV2	—	—
Basic ordering unit (pieces)	1000	2500	2500	500	500

* Denotes h_{FE}

(96-227-D85)